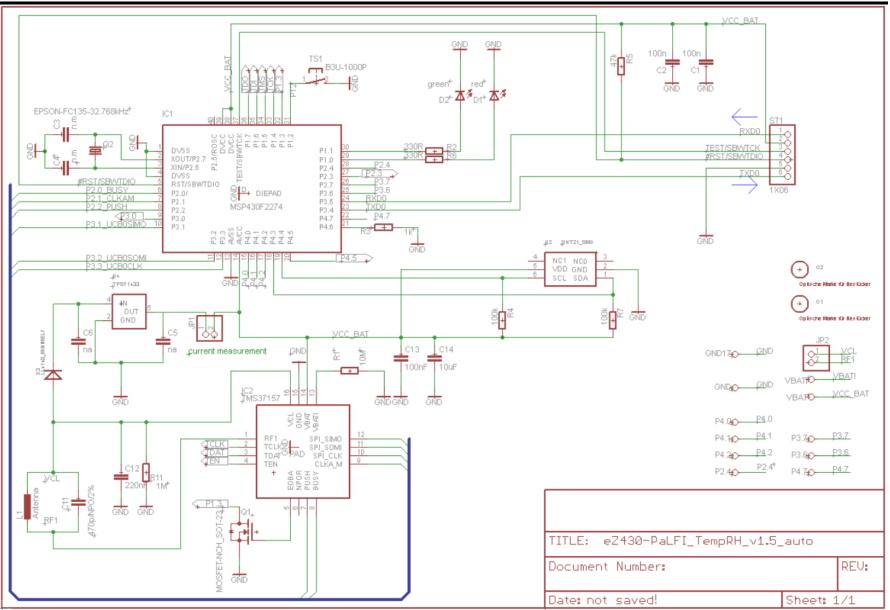
Andre Frantzke Lit SWRA395 Reference Design # Á/ÖÜF€F TIDT ÜØÖÖÖT ÚÙÒÞÙUÜ

TI Designs: Low-Power Battery-Less Wireless Temperature & Humidity Sensor with Passive Low Frequency RFID Schematic



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